

Product/Process Change Notification

PCN N° 2024-215-A

Dear customer,

please find attached our Infineon Technologies AG PCN:

Introduction of several additional wafer test locations affecting several products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2026-04-15.
- Infineon aligns with the widely-recognized JEDEC STANDARD “JESD46”, which stipulates: “Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”
Notwithstanding the aforesaid individual agreements shall prevail.

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

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Chairman of the Supervisory Board Dr. Herbert Diess

Management Board Jochen Hanebeck (CEO), Alexander Gorski, Elke Reichart, Dr. Sven Schneider, Andreas Urschitz

Registered office Neubiberg Commercial register Amtsgericht München HRB 126492

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Products affected

Please refer to attached affected product list PCN_2024-215-A_[customer-no].pdf

Detailed change information

Subject: Introduction of several additional wafer test locations affecting several products

Reason/Motivation: Capacity expansion of wafer test within Infineon test cluster locations to assure continuity of supply and enable flexible manufacturing.

Description	Old	New
TEST FLOW: Move of all or part of electrical wafer test and/or final test to a different test site.	Products are tested on one or two of the below mentioned sites: Infineon Technologies AG, Regensburg, Germany.	Products are tested on all of the below mentioned sites: Infineon Technologies AG, Regensburg, Germany AND
	Infineon Technologies AG, Villach, Austria.	Infineon Technologies AG, Villach, Austria AND
	Infineon Technologies Dresden GmbH & Co. KG, Dresden, Germany.	Infineon Technologies Dresden GmbH & Co. KG, Dresden, Germany AND
	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia.	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia AND
		PLEASE NOTE: for bare die and bare wafer products, "wafer test" is equal to "final test"

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Product identification

Traceability assured via date code and lot number.
No change in SP ordering number

Anticipated impact of change

Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability.
No change in fit, form and function.

DeQuMa-ID(s): SEM-TF-01

Attachments

PCN_2024-215-A_[customer-no].pdf affected product list

Time schedule

Final qualification report	available
First samples available	not applicable, as only addition of test locations.
Intended start of delivery [1]	2026-09-05
Last order date (LOD) [2]	2026-09-05
Last delivery date (LDD) [3]	2027-03-05

[1] Provided date or earlier after customer approval.

[2] Last date where orders for unchanged products will be accepted.

[3] Last date for delivery of unchanged products. Delivery of changed products can be earlier (see Intended start of delivery) and depends on approval.

If you have any questions, please do not hesitate to contact your local sales office.